

#### 0.1-4.2GHz SPDT Switch for 3G/4G/5G TX

#### **Features**

- Broadband frequency range: 0.1 to 4.2 GHz
- Low insertion loss: 0.4dB typical @ 2.7 GHz
- High isolation: >23dB @ 2.7 GHz
- Integrated logic
- DFN 1.1mm X0.7mm X0.55mm-6L package

### **Applications**

Cellular 3G/4G/5G N77/N78 TX
Cellular modems , tablets and USB Devices
Other RF front-end modules

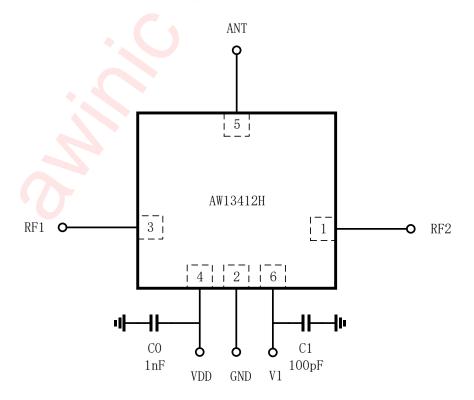
#### **General Description**

The AW13412H is a SPDT switch with low insertion loss and high Isolation. It can be used to support band switching and mode switching for cellular 3G/4G/5G, data cards and tablets.

The symmetrical design of internal ports makes it convenient for PCB routing and adjustment of receiving and transmitting signals. The band/mode switching is realized by the GPIO pins as referenced in the chip block diagram and the control logic.

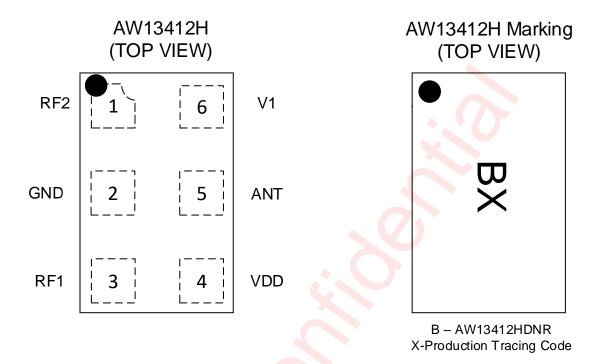
The AW13412H is provided in a compact DFN 1.1mm x 0.7mm x 0.55mm-6L package.

## **Typical Application Circuit**





# **Pin Configuration And Top Mark**

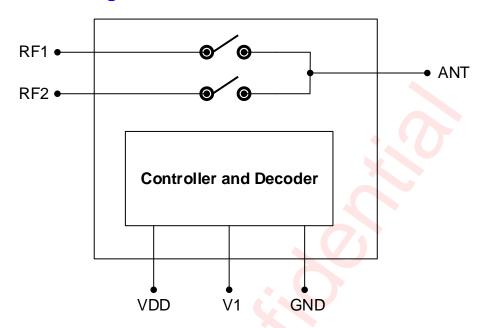


# pin Definition

No.	NAME	DESCRIPTION			
1	RF2	RF I/O path 2			
2	GND	Ground			
3	RF1	RF I/O path 1			
4	VDD	DC power supply			
5	ANT	Antenna port			
6	V1	DC control voltage 1			



# **Functional Block Diagram**





## **Ordering Information**

Part Number	Temperature	Package	Marking	Moisture Sensitivity Level	Environmental Information	Delivery Form
AW13412HDNR	-40℃~85℃	DFN 1.1mmX0.7mm X0.55mm-6L	В	MSL1	ROHS+HF	3000 units/ Tape and Reel

# **Absolute Maximum Ratings**(NOTE1)

PARAMETER	RANGE					
Supply Voltage Rang	Supply Voltage Range VDD					
Control Voltage Range	Control Voltage Range V1					
RF input power(RF	1/RF2)		35dBm			
Operating Free-air Tempe	Operating Free-air Temperature Range					
Storage Temperatur	Storage Temperature T <sub>STG</sub>					
Lead Temperature (Solderin	260°C					
	ESD (NOT	TE 2)				
НВМ			±1000V			
CDM	±500V					

NOTE1: Conditions out of those ranges listed in "absolute maximum ratings" may cause permanent damages to the device. In spite of the limits above, functional operation conditions of the device should within the ranges listed in "recommended operating conditions". Exposure to absolute-maximum-rated conditions for prolonged periods may affect device reliability.

NOTE2: The human body model is a 100pF capacitor discharged through a 1.5k $\Omega$  resistor into each pin. Test method: ESDA/JEDEC JS-001-2017. CDM test method ESDA/JEDEC JS -002-2018.



## **Electrical Characteristics**

VDD=2.8V, V1=0/1.8V, PIN=0dBm, Temp=+25°C,  $Z_0$ =50 $\Omega$ . (unless otherwise noted)

	PARAMETER	TEST CONDITION	MIN	TYP	MAX	UNIT
DC Specif	ications					
VDD	Supply Voltage		2.5	2.8	3.3	V
IDD	Supply Current			26	50	μА
VCTL_H VCTL_L	Control Voltage High Low		1 0		VDD 0.3	V
Трир	Power Up Setting Time	50% of VDD voltage to 90% of final RF power, switching between RF1/2			10	μѕ
Tsw	Switching On/Off Time	50% of final control voltage to 10%/90% of final RF power, switching between RF1/2		0.7	1.2	μs
RF Specifi	cations					
IL	Incortion Ioog/ANIT nin to	0.1-1.0G 1.0-2.0G		0.3 0.34	0.4 0.45	dB dB
	Insertion loss(ANT pin to RF1/RF2)	2.0-2.7G 2.7-4.2G		0.36 0.53	0.50 0.67	dB dB
ISO	Isolation (ANT pin to RF1/RF2)	0.1-1.0G 1.0-2.0G 2.0-2.7G 2.7-4.2G	33 26 23 18	37 29 27 23		dB dB dB dB
RL	Input return loss (ANT pin to RF1/RF2)	0.1-1.0G 1.0-2.0G 2.0-2.7G 2.7-4.2G	22 20 18 12	30 28 23 15		dB dB dB dB
2fo	Second harmonics (ANT pin to RF1/RF2)	PIN=+26dBm, 900MHz		88		dBc
3fo	Third harmonics (ANT pin to RF1/RF2)	PIN=+26dBm, 900MHz		83		dBc
P <sub>0.1dB</sub>	0.1dB Compression Point (ANT pin to RF1/RF2)	0.1-4.2GHz		35		dBm



## **Detailed Functional Description**

It is very important that the user adheres to the correct power-on/off sequence in order to avoid damaging the device. The control signal V1 should be set to 0V unless VDD is set in the operating voltage range.

#### Power ON:

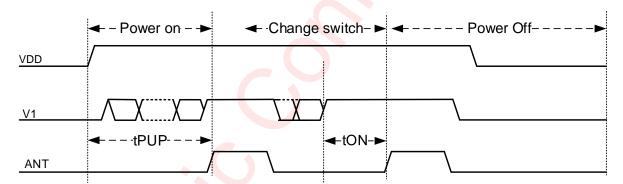
- 1) Apply voltage supply --- VDD
- 2) Set Controls---V1
- 3) Apply RF input

Change switch position from one RF port to another:

- 1) Remove RF input
- 2) Change control voltages V1 to set the switch to desired RF port
- 3) Apply RF input

#### Power OFF:

- 1) Remove RF input
- 2) Remove control voltages-V1
- 3) Remove VDD input



Power on/Change switch/Power off sequence

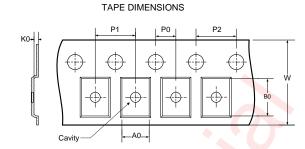
# **Control Logic**

Control Pins	Switch	h RF I/O
V1	RF1	RF2
0	ON	Isolation
1	Isolation	ON



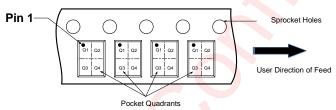
# **Tape And Reel Information**

# REEL DIMENSIONS 0



- A0: Dimension designed to accommodate the component width
- B0: Dimension designed to accommodate the component length
- K0: Dimension designed to accommodate the component thickness W: Overall width of the carrier tape
- P0: Pitch between successive cavity centers and sprocket hole
  P1: Pitch between successive cavity centers
- P2: Pitch between sprocket hole
- D1: Reel Diameter
- D0: Reel Width

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Note: The above picture is for reference only. Please refer to the value in the table below for the actual size

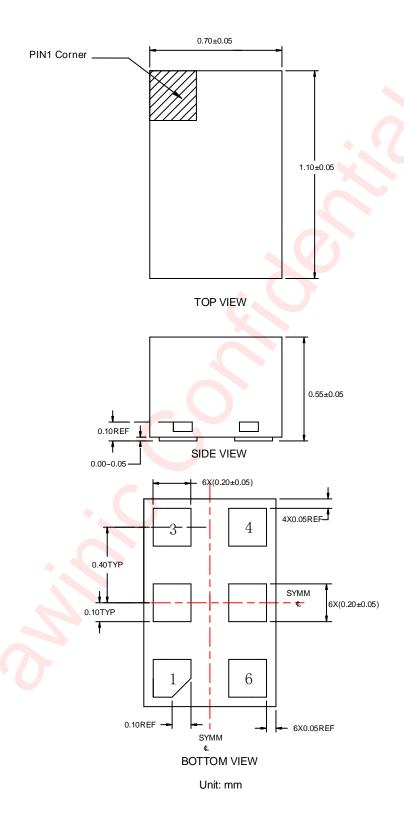
#### DIMENSIONS AND PIN1 ORIENTATION

D1	D0	A0	B0	K0	P0	P1	P2	W	Pin1 Quadrant	
(mm)										
	8.4					2	4	8	Q1	

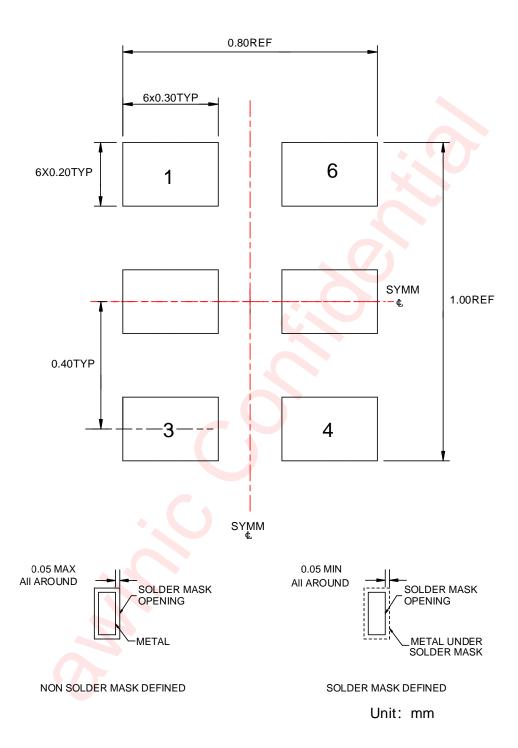
All dimensions are nominal



# **Package Description**



#### **Land Pattern Data**





# **Revision History**

Version	Date	Change Record
V1.0	Oct. 2021	Officially released
V1.1	Aug. 2022	Update ordering information and AMR



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